Lighting ColorSoft Orange

LNJ8A4TN5DA

Round Type

 ϕ 5.0 mm

■ Absolute Maximum Ratings $T_a = 25$ °C

Parameter	Symbol	Rating	Unit		
Power dissipation	P_{D}	125	mW		
Forward current	I_{F}	50	mA		
Pulse forward current *	I_{FP}	I _{FP} 150			
Reverse voltage	V _R	4	V		
Operating ambient temperature	T _{opr}	T _{opr} -25 to +85			
Storage temperature	T _{stg}	-30 to +100	°C		

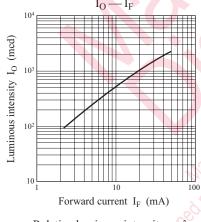
Note) *: The condition of I_{FP} is duty 10%, Pulse width 1 msec.

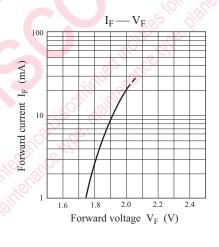
■ Electro-Optical Characteristics $T_a = 25$ °C

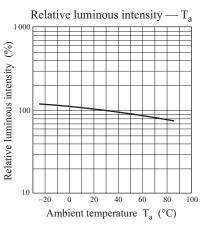
•						ر کام	7.~
Parameter	Symbol		Conditions	Min	Тур	Max	Unit
Luminous intensity *1	I _O	$I_F = 20 \text{ mA}$		800	1 000	50,	mcd
Reverse current	I_R	$V_R = 4 V$		14	50,70	100	μΑ
Forward voltage	$V_{\rm F}$	$I_F = 20 \text{ mA}$		NCJ.	2.0	2.5	V
Dominant emission wavelength *2	λ_{d}	$I_F = 10 \text{ mA}$		600	605	610	nm
Peak emission wavelength	$\lambda_{ m P}$	$I_F = 20 \text{ mA}$	cont.	dillo	610		nm
Spectral half band width	Δλ	$I_F = 20 \text{ mA}$	321, 671;	30,	17		nm

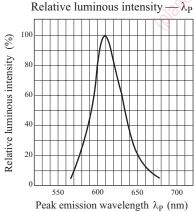
Note) *1: Measurement tolerance: ±20%

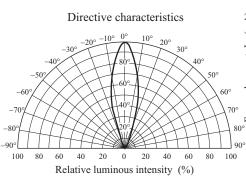
^{*2:} Measurement tolerance: ±2 nm

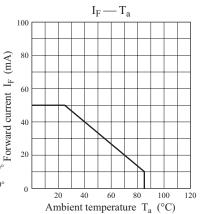




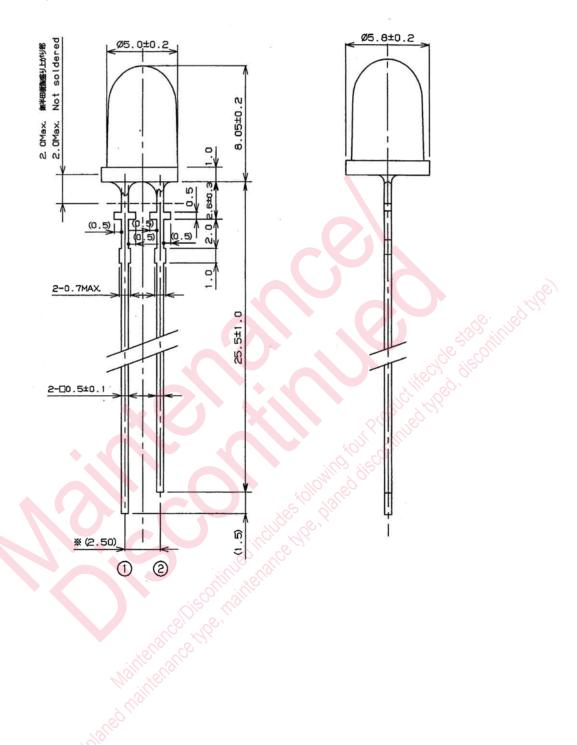








■ Package (Unit: mm)



- Pin name
 - 1: Anode
 - 2: Cathode

2 Ver. AEK

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